

Product Features

- DC – 3500 MHz
- +18.5 dBm P1dB at 900 MHz
- +33 dBm OIP3 at 900 MHz
- 14 dB Gain at 900 MHz
- Single Voltage Supply
- Lead-free / RoHS-compliant / Green SOT-89 package
- Internally matched to 50 Ω

Applications

- Mobile Infrastructure
- CATV / FTTX
- W-LAN / ISM
- RFID
- WiMAX / WiBro

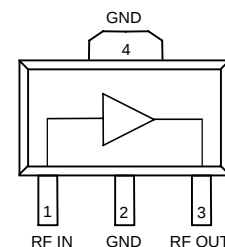
Product Description

The AG602-89 is a general-purpose buffer amplifier that offers high dynamic range in a low-cost surface-mount package. At 900 MHz, the AG602-89 typically provides 14 dB of gain, +33 dBm OIP3, and +18.5 dBm P1dB. The device combines dependable performance with consistent quality to maintain MTTF values exceeding 1000 years at mounting temperatures of +85 °C and is housed in a lead-free/green/RoHS-compliant SOT-89 industry-standard SMT package.

The AG602-89 consists of Darlington pair amplifiers using the high reliability InGaP/GaAs HBT process technology and only requires DC-blocking capacitors, a bias resistor, and an inductive RF choke for operation.

The broadband MMIC amplifier can be directly applied to various current and next generation wireless technologies such as GPRS, GSM, CDMA, and W-CDMA. In addition, the AG602-89 will work for other various applications within the DC to 3.5 GHz frequency range such as CATV and WiMAX.

Functional Diagram



Function	Pin No.
Input	1
Output/Bias	3
Ground	2, 4

Specifications ⁽¹⁾

Parameter	Units	Min	Typ	Max
Operational Bandwidth	MHz	DC		3500
Test Frequency	MHz		900	
Gain	dB		14.2	
Input Return Loss	dB		13	
Output Return Loss	dB		15	
Output P1dB	dBm		+18.7	
Output IP3 ⁽²⁾	dBm		+33.1	
Output IP2	dBm		+47	
Noise Figure	dB		4.4	
Test Frequency	MHz		1900	
Gain	dB	12.6	13.6	14.6
Output P1dB	dBm		+18.4	
Output IP3 ⁽²⁾	dBm		+33.0	
Device Voltage	V		5.16	
Device Current	mA		75	

1. Test conditions: 25 °C, Supply Voltage = +6 V, $R_{bias} = 11.2 \Omega$, 50 Ω System.
2. 3OIP measured with two tones at an output power of +2 dBm/tone separated by 10 MHz. The suppression on the largest IM3 product is used to calculate the 3OIP using a 2:1 rule.

Typical Performance ⁽¹⁾

Parameter	Units	Typical			
Frequency	MHz	500	900	1900	2140
S21	dB	14.4	14.2	13.6	13.5
S11	dB	-12	-13	-16	-16
S22	dB	-16	-15	-14	-14
Output P1dB	dBm	+18.6	+18.7	+18.4	+18.3
Output IP3 ⁽²⁾	dBm	+33.5	+33.1	+33.0	+33.0
Noise Figure	dB	4.3	4.4	4.5	4.5

Absolute Maximum Rating

Parameter	Rating
Storage Temperature	-55 to +150 °C
DC Voltage	+7 V
RF Input Power (continuous)	+10 dBm
Junction Temperature	+177 °C
Thermal Resistance, R_{th}	154 °C / W

Operation of this device above any of these parameters may cause permanent damage.

Ordering Information

Part No.	Description
AG602-89G	InGaP HBT Gain Block (lead-free/green/RoHS-compliant SOT-89 Package)
AG602-89PCB	700 – 2400 MHz Fully Assembled Eval. Board

Standard T/R size = 3000 pieces on a 13" reel.

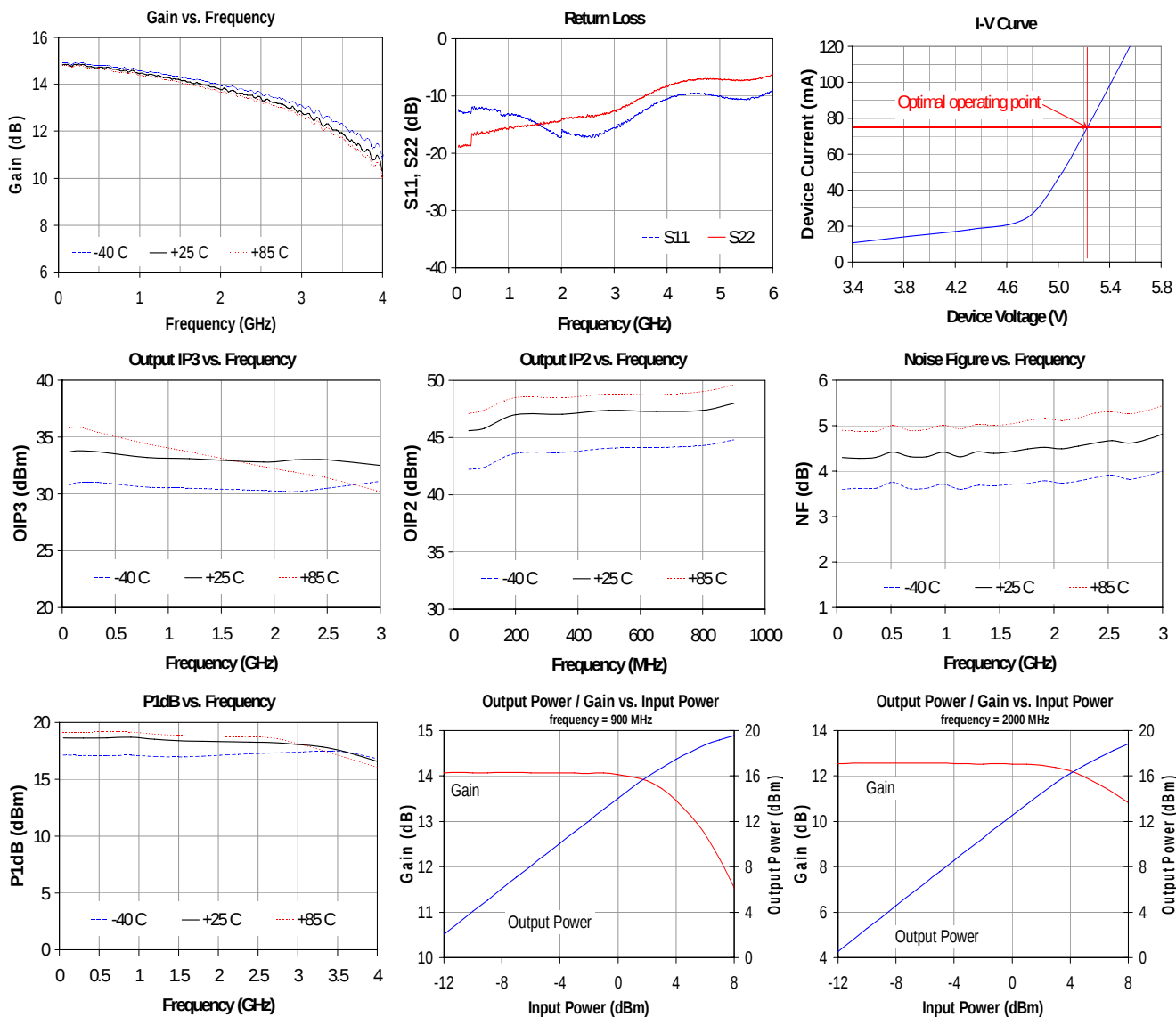
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Typical Device RF Performance

Supply Bias = +6 V, $R_{bias} = 11.2 \Omega$, $I_{cc} = 75 \text{ mA}$

Frequency	MHz	100	500	900	1900	2140	2400	3500	5800
S21	dB	14.5	14.4	14.2	13.6	13.5	13.2	12.2	9.6
S11	dB	-12	-12	-13	-16	-16	-17	-13	-10
S22	dB	-18	-16	-15	-14	-14	-13	-10	-7
Output P1dB	dBm	+18.6	+18.6	+18.7	+18.4	+18.3	+18.3	+17.5	
Output IP3	dBm	+33.8	+33.5	+33.1	+33.0	+33.0	+33.0		
Noise Figure	dB	4.3	4.3	4.4	4.5	4.5	4.6		

- Test conditions: $T = 25^\circ\text{C}$, Supply Voltage = +6 V, Device Voltage = 5.16 V, $R_{bias} = 11.2 \Omega$, $I_{cc} = 75 \text{ mA}$ typical, 50Ω System.
- 3OIP measured with two tones at an output power of +2 dBm/tones separated by 10 MHz. The suppression on the largest IM3 product is used to calculate the 3OIP using a 2:1 rule.
- Data is shown as device performance only. Actual implementation for the desired frequency band will be determined by external components shown in the application circuit.





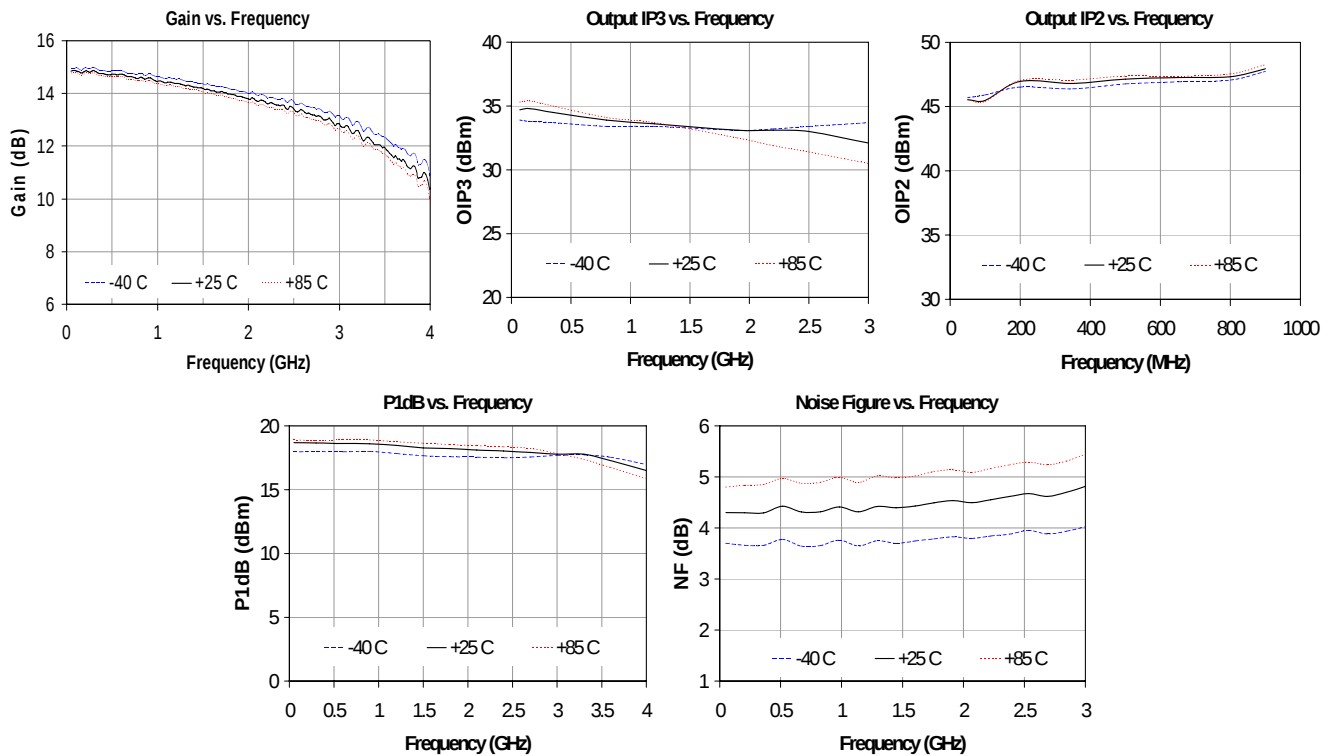
AG602-89

InGaP HBT Gain Block

TriQuint 
SEMICONDUCTOR

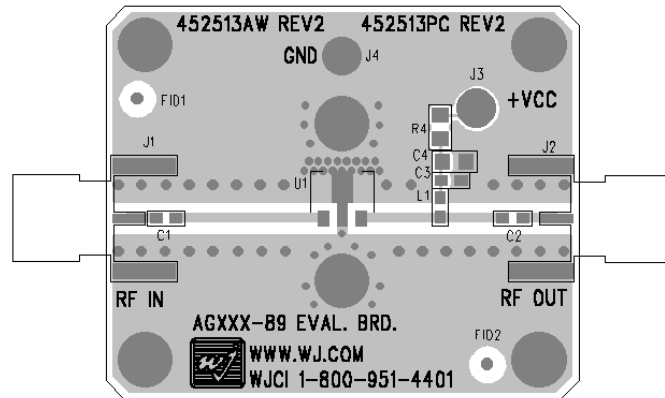
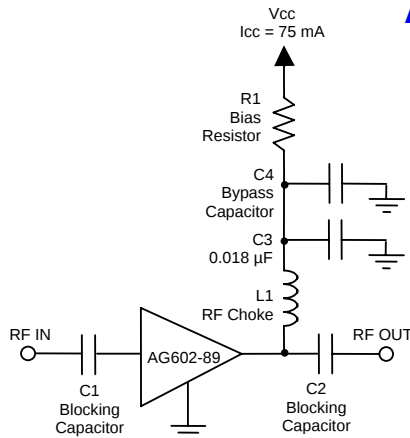
Typical Device RF Performance (cont'd)

Supply Bias = +8 V, $R_{bias} = 38 \Omega$, $I_{cc} = 75 \text{ mA}$



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Application Circuit



Recommended Component Values

Reference Designator	Frequency (MHz)						
	50	500	900	1900	2200	2500	3500
L1	820 nH	220 nH	68 nH	27 nH	22 nH	18 nH	15 nH
C1, C2, C4	.018 µF	1000 pF	100 pF	68 pF	68 pF	56 pF	39 pF

- The proper values for the components are dependent upon the intended frequency of operation.
- The following values are contained on the evaluation board to achieve optimal broadband performance:

Ref. Desig.	Value / Type	Size
L1	39 nH wirewound inductor	0603
C1, C2	56 pF chip capacitor	0603
C3	0.018 µF chip capacitor	0603
C4	Do Not Place	
R1	10.0 Ω 1% tolerance	0805

Recommended Bias Resistor Values

Supply Voltage	R1 value	Size
6 V	11.2 ohms	0805
7 V	24.5 ohms	1210
8 V	38 ohms	1210
9 V	51 ohms	2010
10 V	65 ohms	2010
12 V	91 ohms	2512

The proper value for R1 is dependent upon the supply voltage and allows for bias stability over temperature. WJ recommends a minimum supply bias of +6 V. A 1% tolerance resistor is recommended.

Typical Device Data

S-Parameters ($V_{\text{device}} = +5.16 \text{ V}$, $I_{\text{CC}} = 75 \text{ mA}$, $T = 25^\circ \text{C}$, calibrated to device leads)

Freq (MHz)	S11 (dB)	S11 (ang)	S21 (dB)	S21 (ang)	S12 (dB)	S12 (ang)	S22 (dB)	S22 (ang)
50	-12.45	-179.91	14.65	177.68	-18.47	0.30	-18.85	-178.44
250	-12.80	173.14	14.64	168.81	-18.89	-0.92	-18.64	-178.50
500	-11.98	161.40	14.50	157.67	-18.95	-8.53	-16.31	-178.33
750	-12.30	151.47	14.40	146.73	-18.97	-11.88	-16.00	-176.91
1000	-13.15	140.39	14.28	136.05	-19.19	-19.66	-15.76	-176.74
1250	-13.66	132.83	14.17	125.29	-18.81	-22.16	-15.26	-175.58
1500	-14.64	123.63	14.01	114.91	-18.86	-24.27	-15.11	-174.90
1750	-15.97	112.75	13.85	104.18	-18.94	-28.63	-14.80	-175.62
2000	-17.11	96.84	13.66	93.65	-18.68	-33.27	-14.28	-177.69
2250	-16.83	69.35	13.46	83.50	-18.54	-37.00	-13.75	-168.13
2500	-17.16	59.34	13.32	75.95	-19.15	-44.64	-13.33	-178.03
2750	-16.62	55.01	13.10	65.23	-18.55	-48.27	-13.21	168.67
3000	-15.52	52.50	12.84	54.89	-18.59	-51.43	-12.58	151.61
3250	-14.36	50.49	12.59	44.74	-18.62	-55.38	-11.68	133.62
3500	-12.98	48.86	12.26	34.37	-18.77	-61.67	-10.45	117.29
3750	-11.45	46.31	11.88	24.22	-18.67	-67.58	-9.21	103.08
4000	-10.56	43.88	11.51	14.12	-18.75	-72.12	-8.31	91.70
4250	-9.85	41.17	11.18	4.58	-18.49	-77.01	-7.57	81.65
4500	-9.57	37.68	10.85	-5.08	-18.56	-82.75	-7.25	72.53
4750	-9.72	34.04	10.64	-15.21	-18.35	-87.23	-7.09	64.42
5000	-9.99	28.26	10.44	-25.10	-18.54	-92.28	-7.07	56.77
5250	-10.47	20.24	10.28	-35.32	-18.23	-100.76	-7.28	47.25
5500	-10.65	10.13	10.00	-46.33	-17.94	-107.33	-7.18	37.35
5750	-10.11	-0.98	9.79	-57.68	-17.99	-114.40	-6.88	24.19
6000	-8.96	-13.41	9.41	-69.50	-18.15	-123.08	-6.18	10.75

Device S-parameters are available for download off of the website at: <http://www.wj.com>

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AG602-89G (Green / Lead-free SOT-89 Package) Mechanical Information

This package is lead-free/Green/RoHS-compliant. It is compatible with both lead-free (maximum 260 °C reflow temperature) and leaded (maximum 245 °C reflow temperature) soldering processes. The plating material on the leads is NiPdAu.

Outline Drawing

